There is a wide selection of isolated gate drivers that operate on a unipolar power supply on the secondary side (the side driving the power device), but much fewer gate driver devices that allow for explicit bipolar voltage drives. One method to overcome this lack of negative gate drive devices is to offset the gate driver from the power device, thereby creating a negative gate drive relative to the source or drain of the power device, while the gate driver IC still only sees a unipolar supply. Unipolar and bipolar gate drive waveform examples are shown in Figure 1.

![Figure 1](image-url)

**Figure 1.** (a) Unipolar and (b) bipolar gate drive waveforms.

A schematic with ideal voltage sources pictured is shown in Figure 2. In this example, the driver IC is powered by a voltage equal to the sum of $V_1$ and $V_2$, while the gate of the MOSFET is driven to a $+V_1$ in the ON state and a $-V_2$ in the OFF state, relative to the MOSFET source node. Note that in this example, both voltage sources are decoupled with individual capacitors. The effective decoupling seen by the gate driver IC is the series combination of the capacitors, which is less than the value of each individual capacitor. Additional decoupling can be added between $V_{DD}$ and GND if desired, but it is important to keep $C_1$ and $C_2$ as the capacitors provide low impedance paths for the gate current during turn-on and turn-off separately.

Isolated gate driver ICs often come with an undervoltage lockout (UVLO) to prevent a power device from being driven weakly if the gate driver is being driven with too low of a gate voltage. When driving a unipolar gate driver as shown in Figure 2, care must be taken with the expected operation of the UVLO as the UVLO is usually referenced to the ground of the gate driver. Consider a case where $V_1 = 15$ V, $V_2 = 9$ V, and the gate driver UVLO is around 11 V, which is common for IGBT operation. If $V_1$ were to drop more than 4 V, the UVLO would not trigger, but the IGBT would be driven under 11 V during the ON time, thereby underdriving the IGBT.

Creating two separate voltage sources for this purpose can be accomplished by using two isolated power supplies, but cost is often a concern for this approach. If a flyback topology is used, multiple winding taps could be used to obtain multiple voltages relatively easily.

There are isolated voltage source modules that can provide isolated power, and some manufacturers are selecting voltages conducive to power device voltages. One example is RECOM, with devices such as the IGBT targeted product line that produces an isolated $+15$ V and $-9$ V rail.
For such a large voltage swing, the gate driver must be able to withstand a larger range than the range at which other devices were targeted. Two gate drivers that work well with these voltages are ADI’s ADuM4135 and ADuM4136 IGBT gate drivers with iCoupler® technology, which have a recommended voltage range that allows up to 30 V. Both provide a dedicated ground pin on the output side, allowing the driver UVLO to be referenced against the positive supply rail. The ADuM4135 also includes an integrated Miller Clamp, which can further help suppress the Miller induced turn-on gate voltage bump.

A simple method for creating a bipolar supply from a single voltage source is to create a second voltage source using a biased Zener diode. Although gate drivers provide high currents during the turn-on and turn-off of a power device, the average current actually needed from the power supply is relatively low—often in the tens of mA range for most applications.

The Zener diode can be placed to either regulate the positive or the negative voltage, and can be selected based on which rail needs higher accuracy. The example shown in Figure 3 is setup to regulate the positive voltage more than the negative voltage. One reason to regulate the positive voltage could be if the gate being driven has a tight tolerance on the gate voltage requirements, such as in the case of some GaN devices. Regulating the positive supply also has the added benefit of allowing the UVLO of the gate driver to act as expected, since any fluctuation in V3 will be attenuated by the Zener diode until V3 is too low to support the Zener voltage.

Using the Zener diode method to create two supplies out of a single supply also has the benefit of layout savings. Not only does a Zener diode and a resistor effectively replace an entire isolated voltage source, but by using a unipolar isolated gate driver, a six pin device can be used, such as ADI’s ADuM4120 with iCoupler technology—saving even more space around the gate driver IC along the isolated creepage area.

A reference example of the Zener diode bipolar setup was created using ADI’s ADuM4121 and GaN Systems’ GS66508T to create a half bridge. The example was designed to have a +5 V and −4 V drive referenced to the device source. The example could easily be adapted to have +6 V and −3 V drive by using a different Zener diode, and the same 9 V isolated power supply. A large deadtime is used to separate the Miller bump from other turn-off transients visually, but in practice the ADuM4121 allows for much shorter deadtimes in the tens of ns range, which is an important metric for high efficiency GaN designs.

Creating a negative gate volt drive that can mitigate Miller effect parasitic turn-on does not have to be complicated. Many existing gate drivers that are unipolar in operation can be operated to easily drive a gate negative with minimal external circuitry. There are some implications to consider, such as the effective UVLO voltage, but the benefit of such operation is great.

Ryan Schnell [ryan.schnell@analog.com] is an applications engineer at Analog Devices. His responsibilities include isolated gate drivers that use iCoupler technology to achieve isolation, as well as various power management products. He holds a B.S. and M.S in electrical engineering, and a Ph.D. in power electronics from the University of Colorado.